

Single Stage Flyback & PFC Regulator With Primary Side Control For LED Lighting

Features

- Primary side control eliminates the opto-coupler
- Internal 600V Power MOSFET
- Valley turn-on of the primary MOSFET to achieve lower switching losses
- Power factor >0.95@230VAC
- THD<5%@230VAC
- Reliable short LED and Open LED protection
- Quick start up:<500ms
- Low start up current:15µA typical
- External thermal regulation
- Package: SOIC-8

Applications

LED Lighting

Descriptions

The DIO8604S consists of an integrated single stage Flyback && PFC regulator and 600V power MOSFET, specifically designed for a high performance off-line converter with minimal external components targeting at LED lighting applications.

The DIO8604S drives the Flyback converter in the quasi-resonant mode to achieve higher efficiency. and keeps the Flyback converter in constant on time operation to achieve high power factor.

This chip adopts special design to achieve quick start up and reliable protection for safety requirement.

Block Diagram

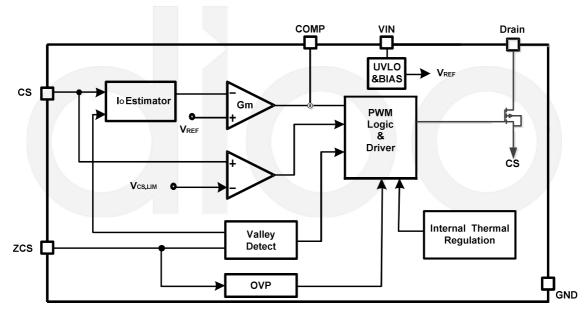


Figure1 Block Diagram



Ordering Information

Order Part Number	Top Marking		T _A	Package	
DIO8604SCS8	DIO8604S	Green	-40 to +125°C	SOIC-8	Tape & Reel, 2500

Pin Assignments

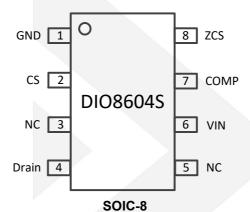


Figure 2 Pin Assignment (Top View)

Pin Definitions

Pin Name	Description		
COMP	Loop compensation pin. Connect a RC network across this pin and ground to stabilize the control		
	loop.		
Drain	Power MOSFET Drain Pin. The Drain pin is connected to the primary lead of the transformer.		
	Current sense pin. Connect this pin to the source of the primary switch. Connect the sense resistor		
	across the source of the primary switch and the GND pin.		
CS	(current sense resister Resistor: $R_{CS} = k \times \frac{V_{ref} \times N_{ps}}{I_{out}}$, k=0.167)		
	Also this pin used to detect transformer and secondary is short or not.		
GND	Ground pin.		
VIN	Power supply pin. This pin also provides output over voltage protection along with ZCS pin.		
	Inductor current zero-crossing detection pin. This pin receives the auxiliary winding voltage by a		
	resister divider and detects the inductor current zero crossing point. This pin also provides over		
zcs	voltage protection and line regulation modification function simultaneously. If the voltage on this pin		
	is above V _{ZCS,OVP} , the IC would enter over voltage protection mode. Good line regulation can be		
	achieved by adjusting the upper resistor of the divider.		
NC	Not Connect.		



Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Rating" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other condition beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maxim rating conditions for extended periods may affect device reliability.

Par	rameter	Rating	Unit	
VIN		-0.3 to 33	V	
Drain		600	V	
Supply Current I _{VIN}		15	mA	
ZCS		-0.3 to VIN+0.3	V	
CS, COMP		-0.3 to 5	V	
Power Dissipation, P _D @ T _A = 25°C	, SOIC-8	1.1	W	
Package Thermal Resistance,	θ _{JA}	100	°C/W	
SOIC-8	Өлс	50		
Storage Temperature Range		-65 to 150	°C	
Junction Temperature Range		150	°C	
Lead Temperature Range		260	°C	
ESD	HBM, JEDEC: JESD22-A114	2000	V	
LOD	MM, JEDEC: JESD22-A115	200	V	

Recommend Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended Operating conditions are specified to ensure optimal performance to the datasheet specifications. DIOO does not Recommend exceeding them or designing to Absolute Maximum Ratings.

Parameter	Rating	Unit		
Supply Voltage	9.5 to 27	V		
Ambient Temperature Range	-40 to 125	°C		



Electrical Characteristics

 V_{IN} = 12V, T_A = 25°C, unless otherwise specified.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Uni
V _{VIN,ON}	VIN turn-on threshold			25.3		V
$V_{\text{VIN,OFF}}$	VIN turn-off threshold			8.5		V
V _{VIN,OVP}	VIN OVP voltage			30		V
I _{ST}	Start up Current	V _{VIN} < V _{IN,OFF}		15		μA
IVIN_OVP	Shunt current in OVP mode	After V _{VIN} >V _{VIN,OVP} , then set VIN=15V	1.6	2	2.5	m/
IQ	Quiescent Current	No switching		0.26		m/
I _{VIN}	Operation current	C _L =100pF,f=15kHz	S.	0.36		m/
Error Amplifier Se	ection					
V_{REF}	Internal reference voltage		0.294	0.3	0.306	V
ZCS pin Section				•	•	•
V _{ZCS} , OVP	ZCS pin OVP voltage threshold			1.5		V
V _{FAST_ST}	Fast start up threshold			0.55		٧
Current Sense Se	ction(Source PIN of integrated MOSF	ET)		•	•	•
$V_{\text{CS.LMT}}$	Current limit reference voltage			0.45		V
$V_{\text{CS.TR}}$	Protection limit for TR short			0.9		V
K ₂	CC Feed forward coefficient			0.1		
R _{K2}	CC Feed forward resistor R _{K2}			340		Ω
PWM Section				•	•	•
T _{ON.MAX}	Max on time	COMP high clamp		15.7		μs
T _{LEB}	Leading edge blanking time			300		ns
T _{OFF,MAX}	Max OFF time			151		μs
T _{LEB.ZCD}	ZCD Blanking Time	After turn off		2		με
f _{MAX}	Maximum switching frequency			115		kH
Power MOSFET S	ection					
V _{BVDSS}	Break-down Voltage	I _{DS} =250μA, Τ _J =25℃	600	630		V
I _{DSS}	Off-state drain current	V _{DS} =600V, V _{GS} =0V, T _J =25°C			1	μA
R _{DSON}	On-state resistance	V _{GS} =10V, I _{DS} =3.5A,		2.1	2.6	Ω
Thermal Section	1	1		1	ı	1
T _{SD}	Thermal Shutdown Temperature			150		°C



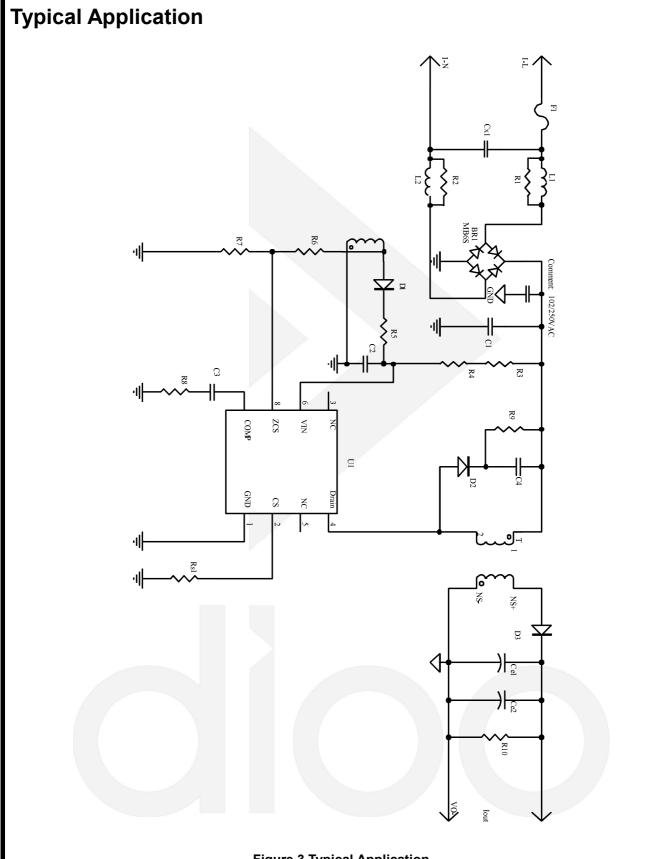


Figure 3 Typical Application



Application Information

Start up

After AC or DC supply is powered on, the capacitor C_{VIN} across VIN and GND pin is charged up by BUS voltage through a start up resistor R_{ST} . Once V_{VIN} rises up to V_{VIN-ON} , the internal blocks start to work and PWM output is enabled.

Shut down

After AC supply or DC BUS is powered off, the energy stored in the BUS capacitor will be discharged. When the auxiliary winding of Flyback transformer can't supply enough energy to VIN pin, V_{VIN} will drop down. Once V_{VIN} is below $V_{VIN-OFF}$, the IC will stop working and V_{COMP} will be discharged to zero.

Primary-side constant-current control

Primary side control is applied to eliminate secondary feedback circuit or opto-coupler, which reduces the circuit cost.

Quasi-Resonant Operation

QR mode operation provides low turn-on switching losses for Flyback converter.

Over Voltage Protection (OVP) & Open LED Protection (OLP)

The output voltage is reflected by the auxiliary winding voltage of the Flyback transformer, and both ZCS pin and VIN pin provide over voltage protection function. When the load is null or large transient happens, the output voltage will exceed the rated value. When V_{VIN} exceeds $V_{VIN,OVP}$ or V_{ZCS} exceeds $V_{ZCS,OVP}$, the over voltage protection is triggered and the IC will discharge V_{VIN} by an internal current source $I_{VIN,OVP}$. Once V_{VIN} is below $V_{VIN,OFF}$, the IC will shut down and be charged again by BUS voltage through start up resistor. If the overvoltage condition still exists, the system will operate in hiccup mode.

Short Circuit Protection (SCP)

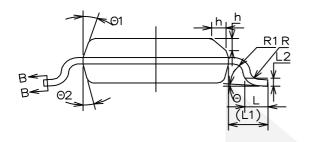
When the output is shorted to ground, the output voltage is clamped to zero. The voltage of the auxiliary winding is proportional to the output winding, so valley signal cannot be detected by ZCS. Without valley detection, MOSFET cannot be turned ON until maximum off time $t_{OFF,MAX}$ is matched. If MOSFET is turned ON by $t_{OFF,MAX}$ 64times continuously, IC will be shut down and enter into hiccup mode. If the output voltage is not low enough to disable valley detection in short condition, V_{VIN} will dropdown without auxiliary winding supply. Once V_{VIN} is below $V_{VIN,OFF}$, the IC will shut down and be charged again by the BUS voltage through the start up resistor. If the short circuit condition still exists, the system will operate in hiccup mode.

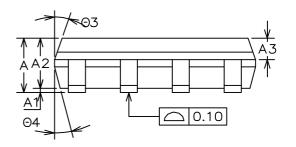
Internal Thermal Regulation

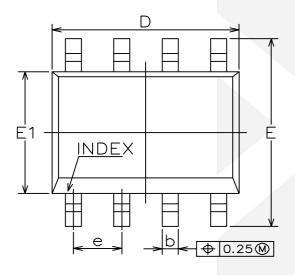
As the driver temperature is higher than the threshold temperature, it reduces the output current and then a balance is achieved between output power and temperature, thereby improve system reliability.

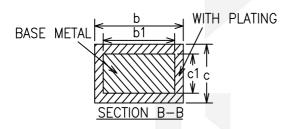


Physical Dimensions: SOIC-8









COMMON DIMENSIONS						
	(UNITS OF MEASURE=MILLIMETER)					
Symbol	MIN	NOM	MAX			
Α	1.35	1.55	1.75			
A1	0.10	0.15	0.25			
A2	1.25	1.40	1.65			
A3	0.50	0.60	0.70			
b	0.38	ı	0.51			
b1	0.37	0.42	0.47			
С	0.17	ı	0.25			
c1	0.17	0.20	0.23			
D	4.80	4.90	5.00			
E	5.80	6.00	6.20			
E1	3.80	3.90	4.00			
e	1.27BSC					
L	0.40 0.60 0.80					
L1	1.04REF					
L2	0.25BSC					
R	0.07	ı	-			
R1	0.07	ı	-			
h	0.30	0.40	0.50			
Θ	0°	-	8°			
Θ1	15°	17°	19°			
Θ2	11°	13°	15°			
Θ3	15°	17°	19°			
Θ4	11°	13°	15°			



CONTACT US

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